The Hawaii Sheet Metal Industry Scholarship for the Honolulu Community College Sheet Metal Program
Academic Year 2017-18

The Hawaii State Sheet Metal Industry offers twelve scholarships to include payment of annual tuition, student fees, and purchase of books to Hawaii residents who have completed graduation requirements or earned a GED and are interested in pursuing a one-year certificate in Sheet Metal and Plastics Technology. For questions, call the training coordinator for the Joint Apprenticeship Committee at 841-6106.

Eligibility Criteria:

1. Any person graduating from a Hawaii public or private high school or completing a General Educational Developmental program.
2. Must have been a resident of Hawaii for five years.

Selection Criteria:

Career goal and other evidence of personal motivation and eagerness to learn are among the criteria for selection.

Instructions to Applicant:

1. Complete this application. Submit a certified copy of your high school transcript directly to the Hawaii Joint Apprenticeship Committee for the Sheet Metal Industry.
2. Attached are two copies of a form titled Confidential Letters of Recommendation. Please ask two persons other than family members to provide letters of recommendation. For graduating high school seniors, at least one reference must be from an instructor, counselor or staff member at your school. Have these individuals mail their letters of recommendation directly to the Hawaii Joint Apprenticeship Committee for the Sheet Metal Industry.
3. Application along with supporting documents must be submitted by JUNE 2, 2017. Mail all documents to:

The Hawaii Joint Apprenticeship Committee for the Sheet Metal Industry
1405 North King Street, Room 403
Honolulu, Hawaii 96817

Conditions:

1. Scholarship recipients agree to release their grade and/or progress report to the Joint apprenticeship Committee for the Sheet Metal Industry.
2. Scholarship recipients who do not maintain a 2.0 GPA in the SMP curriculum or drop out will have their scholarship revoked and shall be responsible for all fees or penalties due to Honolulu Community College.
3. I have read and agree to the above conditions: ______________________________, ______________________________

Signature Date
CANDIDATE’S APPLICATION FORM – Part I

Applicant Number _______________ *
(*to be assigned by evaluation committee)

FULL NAME OF APPLICANT ______________________________________________________________

Date of Birth _______________________________________

Social Security Number ______________________________

Home Address _____________________________________________________________________________

Mailing Address ____________________________________________________________________________

Telephone Number _________________________________

Father’s Full Name __________________________________________________________________________

Father’s Address, if different from applicant ______________________________________________________

Mother’s Full Name _________________________________________________________________________

Mother’s Address, if different from applicant _____________________________________________________

Guardian (if other than parent) _________________________________________________________________

Guardian’s Address __________________________________________________________________________

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<th>Title</th>
<th>Hrs worked Per week</th>
<th>Duties</th>
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I hereby declare that I prepared this application and that the information provided is correct and complete. I am willing to be interviewed regarding this application.

Applicant’s Signature _____________________________________________  Date__________________________
CANDIDATE’S APPLICATION FORM – Part 2

**Personal Statement**
Please describe why you have chosen sheet metal as a career choice and to apply for the Hawaii Sheet Metal Industry Scholarship.

Type or print clearly.
If using a word processor, you may attach your statement to the application.
CANDIDATE’S APPLICATION FORM – Part 3

APPLICANT’S SCHOOL INFORMATION

Name of High School ________________________________________________________________

Address/City/State/Zip Code ________________________________________________________________________

Date of Graduation ___________________________________________

POST-HIGH SCHOOL INFORMATION

College, Vocational Technical School, or other post-secondary institutions you have attended or are now attending.

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ACADEMIC ACHIEVEMENT

APPLICANT’S GPA: __________________

Please summarize your achievements while in high school. Feel free to use an extra sheet if necessary.
REFERENCES

Please give the names and addresses of two persons who have known you long enough to form a judgment of your personal qualities, achievements and academic abilities and have each submit a CONFIDENTIAL LETTER OF RECOMMENDATION on the attached form on your behalf by **June 2, 2017**.

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Deadline: JUNE 2, 2017

Please fill out and mail directly to:

Hawaii Joint Apprenticeship Committee for the Sheet Metal Industry
1405 North King Street, Room 403
Honolulu, Hawaii  96817

Applicant’s Name

Last Name     First Name     Middle Initial

Name of Reference _________________________________________________________________

Title/Relationship to Applicant ______________________________________________________

Address __________________________________________________________________________

Daytime Phone ________________________________ Evening Phone _______________________

This applicant is applying for one of twelve scholarships to include tuition and books for the Honolulu Community College Sheet Metal and Plastics Technology Program.

Selection criteria include career goal and other evidence of personal motivation and eagerness to learn.

Please describe your relationship to the applicant and your assessment of the applicant’s attributes.

This statement is confidential and will not be released to the applicant or any other parties other than the Industry Selection Committee.

Please attach your letter to this form and submit to our Selection Committee at the above address.

Signature _____________________________________________  Date _______________________
Deadline: **JUNE 2, 2017**

Please fill out and mail directly to:

Hawaii Joint Apprenticeship Committee for the Sheet Metal Industry
1405 North King Street, Room 403
Honolulu, Hawaii  96817

Applicant’s Name

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Signature _____________________________________________  Date _________________________